

TIDA-00214 RS-485 BoosterPack

Revision History	
Revision	Notes

A

A

B

B

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C

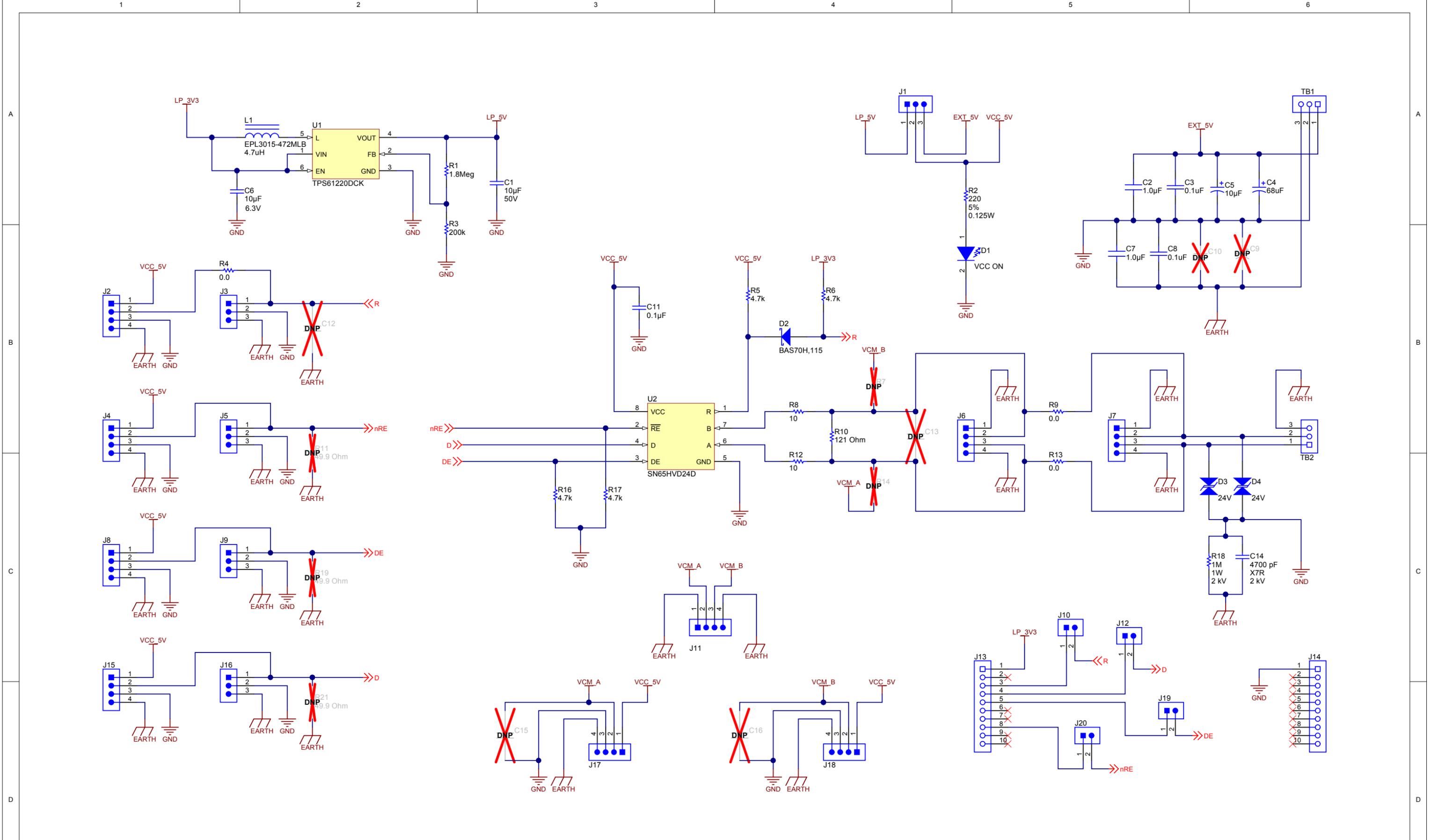
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Number: ISE4015	Rev: E1	Designed for: Public Release	Mod. Date: 7/2/2014
SVN Rev: Not in version control		Project Title: TIDA-00214 RS485 Boosterpack	
Drawn By: Gustavo Martinez		Assembly Variant: 001	Sheet: 1 of 3
Engineer: Gustavo Martinez		File: ISE4015 Cover Sheet.SchDoc	Contact: http://www.ti.com/support
		Size: B	http://www.ti.com
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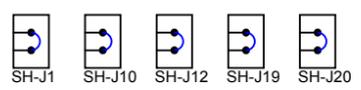


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PCB Number: ISE4015
PCB Rev: E1

PCB
LOGO
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ZZ2
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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Designed for: Public Release		Mod. Date: 5/12/2014		
Project Title: TIDA-00214 RS485 Boosterpack		Sheet Title:		
Number: ISE4015	Rev: E1	Assembly Variant: 001	Sheet: 3 of 3	
SVN Rev: Not in version control	Drawn By:	File: ISE4015 E1 Hdwr.SchDoc	Size: B	
Engineer: Gustavo Martinez	Contact: http://www.ti.com/support		http://www.ti.com	
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